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Stocking Distributor

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[ON Semiconductor](#)
[NTJD4105CT1G](#)

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sales@integrated-circuit.com

NTJD4105C

Small Signal MOSFET 20 V / -8.0 V, Complementary, +0.63 A / -0.775 A, SC-88

Features

- Complementary N and P Channel Device
- Leading -8.0 V Trench for Low $R_{DS(on)}$ Performance
- ESD Protected Gate – ESD Rating: Class 1
- SC-88 Package for Small Footprint (2 x 2 mm)
- Pb-Free Packages are Available

Applications

- DC-DC Conversion
- Load/Power Switching
- Single or Dual Cell Li-Ion Battery Supplied Devices
- Cell Phones, MP3s, Digital Cameras, PDAs

MAXIMUM RATINGS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Parameter		Symbol	Value	Unit
Drain-to-Source Voltage	N-Ch	V_{DSS}	20	V
	P-Ch		-8.0	
Gate-to-Source Voltage	N-Ch	V_{GS}	± 12	V
	P-Ch		± 8.0	
Continuous Drain Current – Steady State (Based on $R_{\theta JA}$)	N-Ch	$T_A = 25^\circ\text{C}$	0.63	A
		$T_A = 85^\circ\text{C}$	0.46	
	P-Ch	$T_A = 25^\circ\text{C}$	-0.775	
		$T_A = 85^\circ\text{C}$	-0.558	
Continuous Drain Current – Steady State (Based on $R_{\theta JL}$)	N-Ch	$T_A = 25^\circ\text{C}$	0.91	
		$T_A = 85^\circ\text{C}$	0.65	
	P-Ch	$T_A = 25^\circ\text{C}$	-1.1	
		$T_A = 85^\circ\text{C}$	-0.8	
Pulsed Drain Current	$tp \leq 10 \mu\text{s}$	I_{DM}	± 1.2	A
Power Dissipation – Steady State (Based on $R_{\theta JA}$)	$T_A = 25^\circ\text{C}$	P_D	0.27	W
	$T_A = 85^\circ\text{C}$		0.14	
Power Dissipation – Steady State (Based on $R_{\theta JL}$)	$T_A = 25^\circ\text{C}$		0.55	
	$T_A = 85^\circ\text{C}$		0.29	
Operating Junction and Storage Temperature		T_J, T_{STG}	-55 to 150	$^\circ\text{C}$
Source Current (Body Diode)	N-Ch	I_S	0.63	A
	P-Ch		-0.775	
Lead Temperature for Soldering Purposes (1/8" from case for 10 s)		T_L	260	$^\circ\text{C}$

THERMAL RESISTANCE RATINGS (Note 1)

Junction-to-Ambient – Steady State	Typ	$R_{\theta JA}$	400	$^\circ\text{C/W}$
	Max		460	
Junction-to-Lead (Drain) – Steady State	Typ	$R_{\theta JL}$	194	
	Max		226	

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

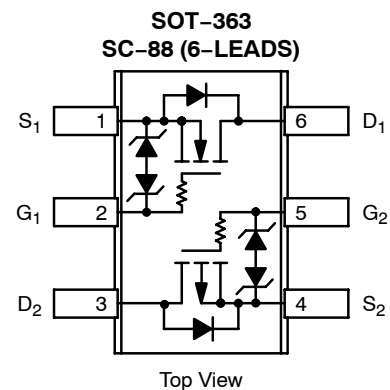
1. Surface mounted on FR4 board using 1 oz Cu area = 0.9523 in sq.



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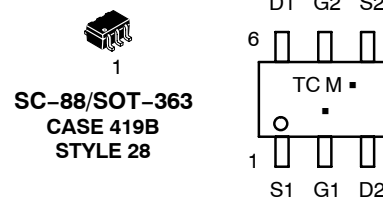
<http://onsemi.com>

$V_{(BR)DSS}$	$R_{DS(on)}$ TYP	I_D Max
N-Ch 20 V	0.29 Ω @ 4.5 V	0.63 A
	0.36 Ω @ 2.5 V	
P-Ch -8.0 V	0.22 Ω @ -4.5 V	-0.775 A
	0.32 Ω @ -2.5 V	
	0.51 Ω @ -1.8 V	



Top View

MARKING DIAGRAM & PIN ASSIGNMENT



SC-88/SOT-363
 CASE 419B
 STYLE 28

TC = Device Code
 M = Date Code
 ■ = Pb-Free Package

(Note: Microdot may be in either location)

ORDERING INFORMATION

See detailed ordering and shipping information in the package dimensions section on page 7 of this data sheet.

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ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	N/P	Test Condition	Min	Typ	Max	Units
Drain-to-Source Breakdown Voltage	$V_{(BR)DSS}$	N	$V_{GS} = 0\text{ V}$	$I_D = 250\ \mu\text{A}$	20	27	V
		P		$I_D = -250\ \mu\text{A}$	-8.0	-10.5	
Drain-to-Source Breakdown Voltage Temperature Coefficient	$V_{(BR)DSS} / T_J$	N				22	$\text{mV}/^\circ\text{C}$
		P				-6.0	
Zero Gate Voltage Drain Current	I_{DSS}	N	$V_{GS} = 0\text{ V}, V_{DS} = 16\text{ V}$	$T_J = 25^\circ\text{C}$		1.0	μA
		P	$V_{GS} = 0\text{ V}, V_{DS} = -6.4\text{ V}$			1.0	
Gate-to-Source Leakage Current	I_{GSS}	N	$V_{DS} = 0\text{ V}$	$V_{GS} = \pm 12\text{ V}$		10	μA
		P		$V_{GS} = \pm 8.0$		10	

ON CHARACTERISTICS (Note 2)

Gate Threshold Voltage	$V_{GS(TH)}$	N	$V_{GS} = V_{DS}$	$I_D = 250\ \mu\text{A}$	0.6	0.92	1.5	V
		P		$I_D = -250\ \mu\text{A}$	-0.45	-0.83	-1.0	
Gate Threshold Temperature Coefficient	$V_{GS(TH)} / T_J$	N				-2.1		$-\text{mV}/^\circ\text{C}$
		P				2.2		
Drain-to-Source On Resistance	$R_{DS(on)}$	N	$V_{GS} = 4.5\text{ V}, I_D = 0.63\text{ A}$			0.29	0.375	Ω
		P	$V_{GS} = -4.5\text{ V}, I_D = -0.57\text{ A}$			0.22	0.30	
		N	$V_{GS} = 2.5\text{ V}, I_D = 0.40\text{ A}$			0.36	0.445	
		P	$V_{GS} = -2.5\text{ V}, I_D = -0.48\text{ A}$			0.32	0.46	
		P	$V_{GS} = -1.8\text{ V}, I_D = -0.20\text{ A}$			0.51	0.90	
Forward Transconductance	g_{FS}	N	$V_{DS} = 4.0\text{ V}, I_D = 0.63\text{ A}$			2.0		S
		P	$V_{DS} = -4.0\text{ V}, I_D = -0.57\text{ A}$			2.0		

CHARGES AND CAPACITANCES

Input Capacitance	C_{ISS}	N	$f = 1\text{ MHz}, V_{GS} = 0\text{ V}$	$V_{DS} = 20\text{ V}$		33	46	pF	
		P		$V_{DS} = -8.0\text{ V}$		160	225		
Output Capacitance	C_{OSS}	N		$V_{DS} = 20\text{ V}$		13	22		
		P		$V_{DS} = -8.0\text{ V}$		38	55		
Reverse Transfer Capacitance	C_{RSS}	N		$V_{DS} = 20\text{ V}$		2.8	5.0		
		P		$V_{DS} = -8.0\text{ V}$		28	40		
Total Gate Charge	$Q_{G(TOT)}$	N		$V_{GS} = 4.5\text{ V}, V_{DS} = 10\text{ V}, I_D = 0.7\text{ A}$		1.3	3.0		nC
		P		$V_{GS} = -4.5\text{ V}, V_{DS} = -5.0\text{ V}, I_D = -0.6\text{ A}$		2.2	4.0		
Threshold Gate Charge	$Q_{G(TH)}$	N		$V_{GS} = 4.5\text{ V}, V_{DS} = 10\text{ V}, I_D = 0.7\text{ A}$		0.1			
		P		$V_{GS} = -4.5\text{ V}, V_{DS} = -5.0\text{ V}, I_D = -0.6\text{ A}$		0.1			
Gate-to-Source Charge	Q_{GS}	N	$V_{GS} = 4.5\text{ V}, V_{DS} = 10\text{ V}, I_D = 0.7\text{ A}$		0.2				
		P	$V_{GS} = -4.5\text{ V}, V_{DS} = -5.0\text{ V}, I_D = -0.6\text{ A}$		0.5				
Gate-to-Drain Charge	Q_{GD}	N	$V_{GS} = 4.5\text{ V}, V_{DS} = 10\text{ V}, I_D = 0.7\text{ A}$		0.4				
		P	$V_{GS} = -4.5\text{ V}, V_{DS} = -5.0\text{ V}, I_D = -0.6\text{ A}$		0.5				

SWITCHING CHARACTERISTICS (Note 3)

Turn-On Delay Time	$t_{d(ON)}$	N	$V_{GS} = 4.5\text{ V}, V_{DD} = 10\text{ V}, I_D = 0.5\text{ A}, R_G = 20\ \Omega$		0.083		μs
Rise Time	t_r				0.227		
Turn-Off Delay Time	$t_{d(OFF)}$				0.786		
Fall Time	t_f				0.506		
Turn-On Delay Time	$t_{d(ON)}$	P	$V_{GS} = -4.5\text{ V}, V_{DD} = -4.0\text{ V}, I_D = -0.5\text{ A}, R_G = 8.0\ \Omega$		0.013		
Rise Time	t_r				0.023		
Turn-Off Delay Time	$t_{d(OFF)}$				0.050		
Fall Time	t_f				0.036		

DRAIN-SOURCE DIODE CHARACTERISTICS

Forward Diode Voltage	V_{SD}	N	$V_{GS} = 0\text{ V}, T_J = 25^\circ\text{C}$	$I_S = 0.23\text{ A}$		0.76	1.1	V
		P		$I_S = -0.23\text{ A}$		0.76	1.1	
		N	$V_{GS} = 0\text{ V}, T_J = 125^\circ\text{C}$	$I_S = 0.23\text{ A}$		0.63		
		P		$I_S = -0.23\text{ A}$		0.63		
Reverse Recovery Time	t_{RR}	N	$V_{GS} = 0\text{ V}, dI_S/dt = 90\text{ A}/\mu\text{s}$	$I_S = 0.23\text{ A}$		0.410		μs
		P		$I_S = -0.23\text{ A}$		0.078		

 2. Pulse Test: pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.

3. Switching characteristics are independent of operating junction temperatures.

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TYPICAL N-CHANNEL PERFORMANCE CURVES ($T_J = 25^\circ\text{C}$ unless otherwise noted)

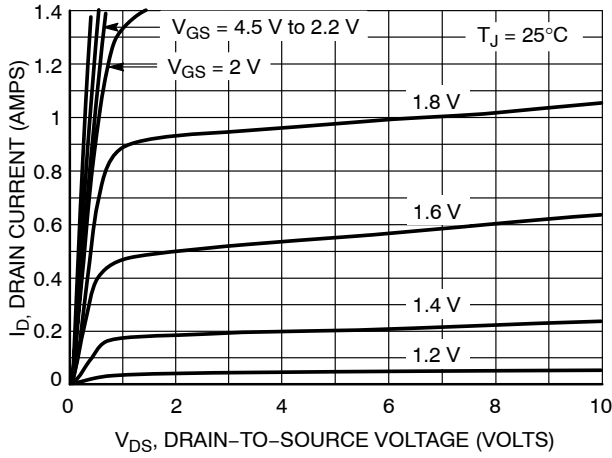


Figure 1. On-Region Characteristics

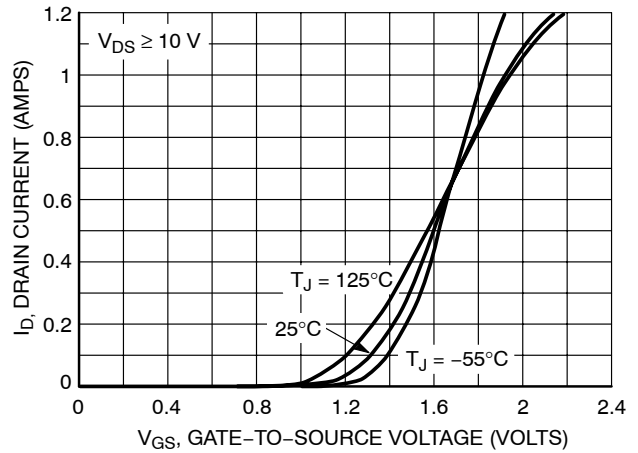


Figure 2. Transfer Characteristics

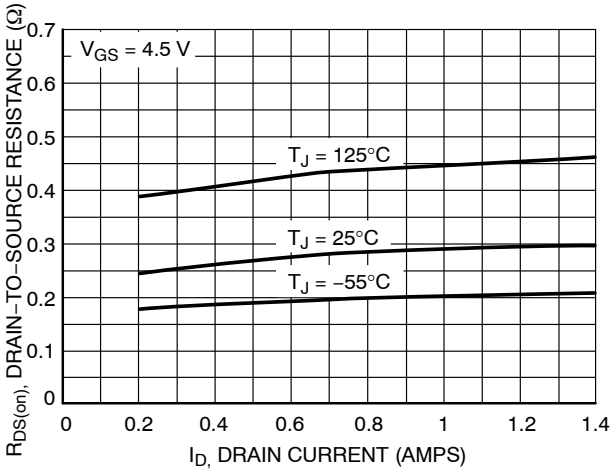


Figure 3. On-Resistance vs. Drain Current and Temperature

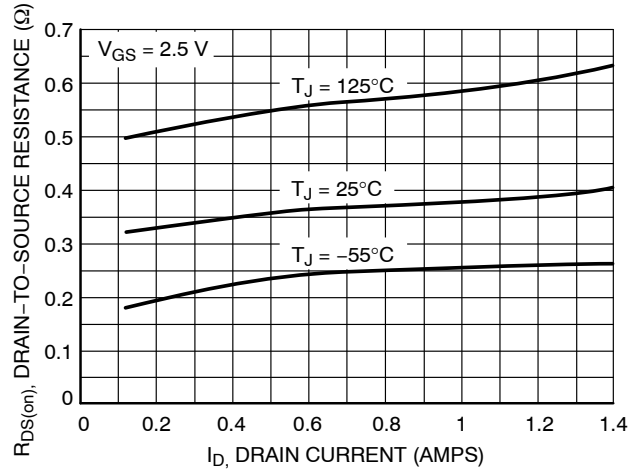


Figure 4. On-Resistance vs. Drain Current and Temperature

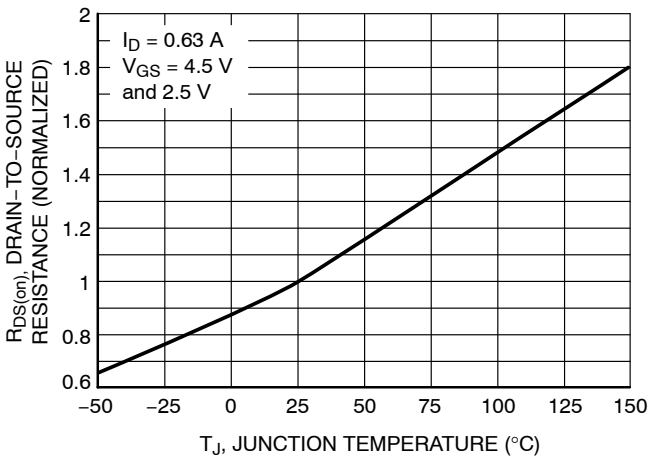


Figure 5. On-Resistance Variation with Temperature

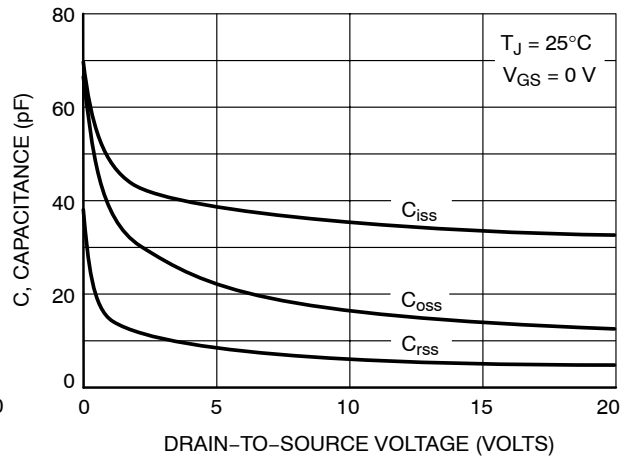


Figure 6. Capacitance Variation

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TYPICAL N-CHANNEL PERFORMANCE CURVES ($T_J = 25^\circ\text{C}$ unless otherwise noted)

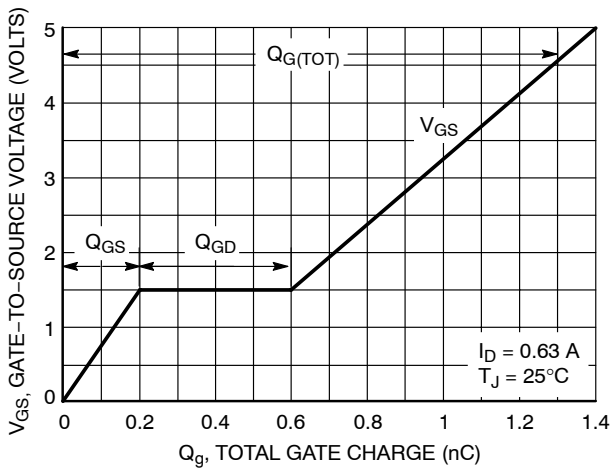


Figure 7. Gate-to-Source and Drain-to-Source Voltage vs. Total Charge

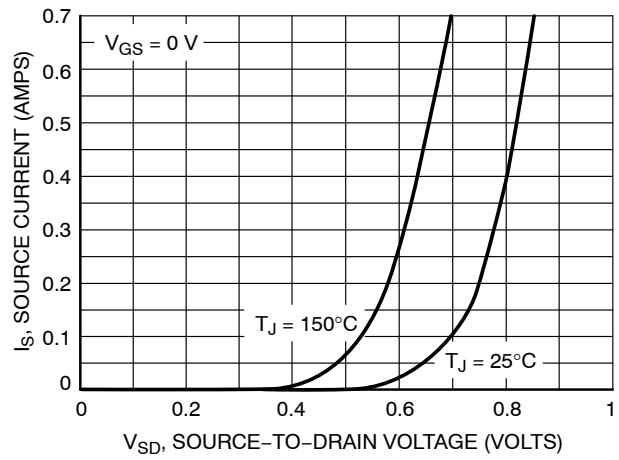


Figure 8. Diode Forward Voltage vs. Current

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TYPICAL P-CHANNEL PERFORMANCE CURVES ($T_J = 25^\circ\text{C}$ unless otherwise noted)

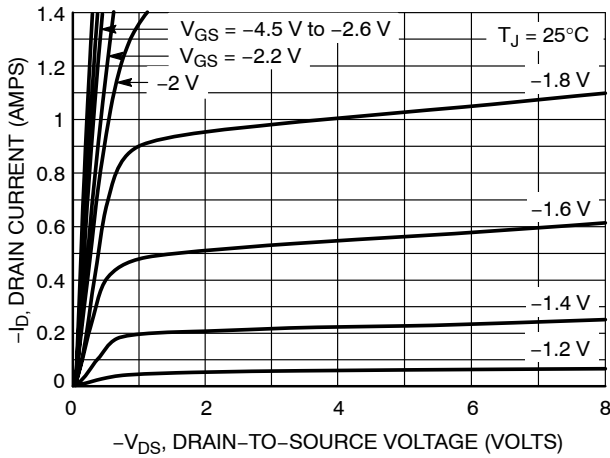


Figure 9. On-Region Characteristics

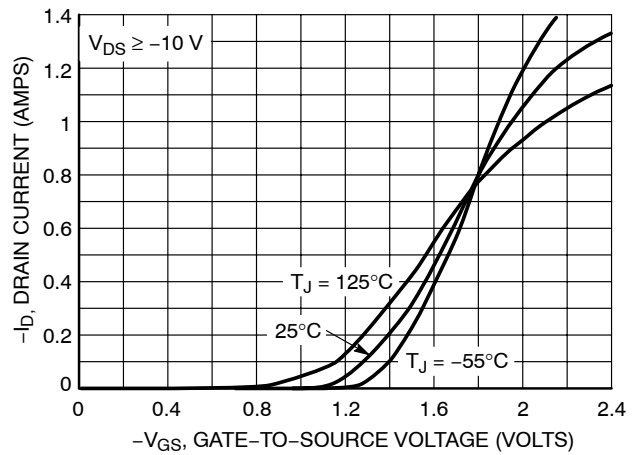


Figure 10. Transfer Characteristics

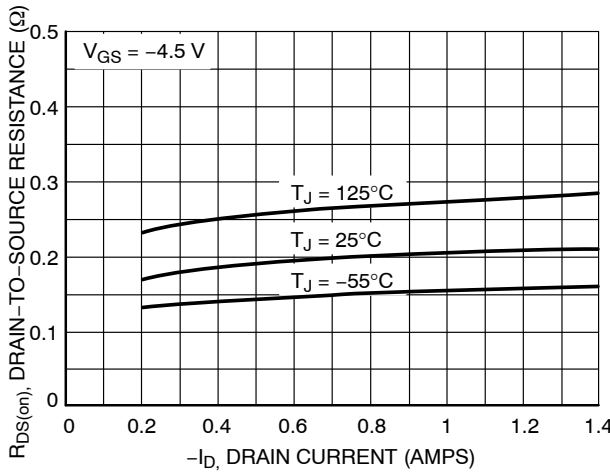


Figure 11. On-Resistance vs. Drain Current and Temperature

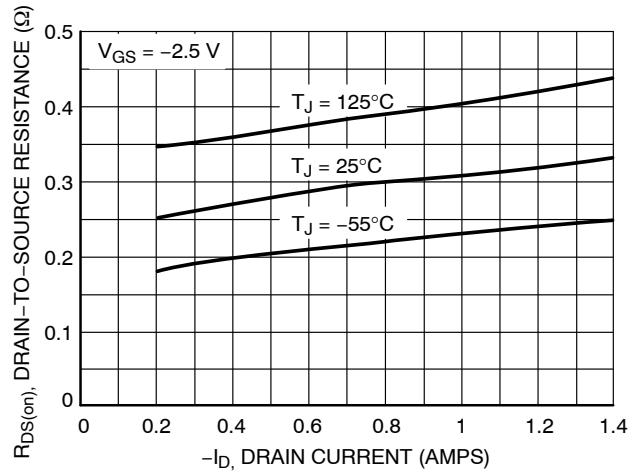


Figure 12. On-Resistance vs. Drain Current and Temperature

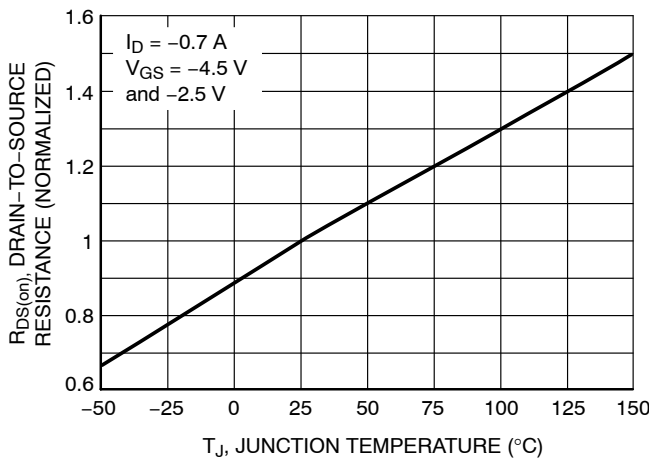


Figure 13. On-Resistance Variation with Temperature

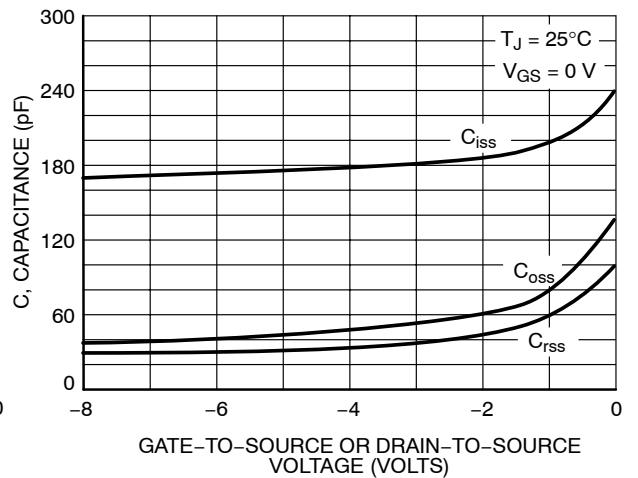


Figure 14. Capacitance Variation

NTJD4105C

TYPICAL P-CHANNEL PERFORMANCE CURVES ($T_J = 25^\circ\text{C}$ unless otherwise noted)

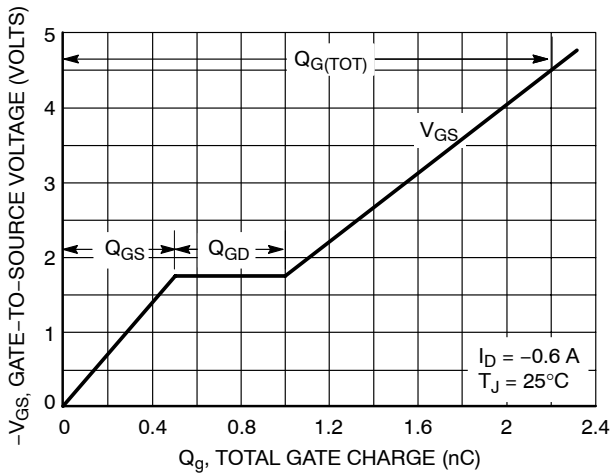


Figure 15. Gate-to-Source and Drain-to-Source Voltage vs. Total Charge

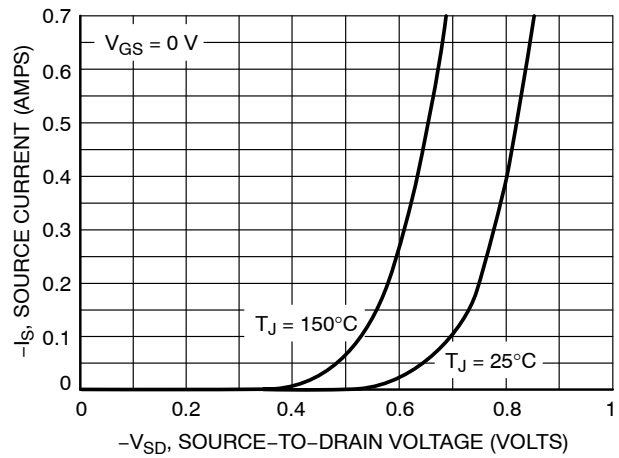


Figure 16. Diode Forward Voltage vs. Current

NTJD4105C**ORDERING INFORMATION**

Device	Package	Shipping [†]
NTJD4105CT1	SOT-363	3000 / Tape & Reel
NTJD4105CT1G	SOT-363 (Pb-Free)	3000 / Tape & Reel
NTJD4105CT2	SOT-363	3000 / Tape & Reel
NTJD4105CT2G	SOT-363 (Pb-Free)	3000 / Tape & Reel
NTJD4105CT4	SOT-363	10,000 / Tape & Reel
NTJD4105CT4G	SOT-363 (Pb-Free)	10,000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

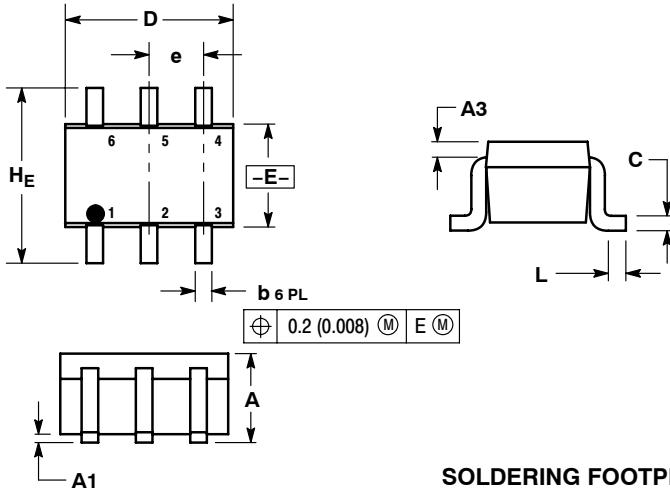
NTJD4105C

PACKAGE DIMENSIONS

SC-88/SC70-6/SOT-363

CASE 419B-02

ISSUE W



\oplus	0.2 (0.008)	M	E	M
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NOTES:

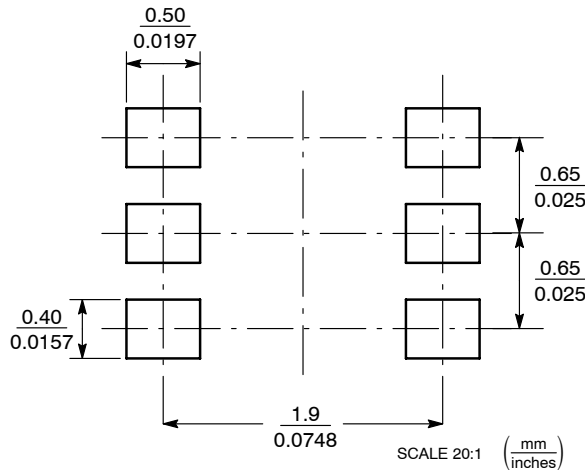
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. 419B-01 OBSOLETE, NEW STANDARD 419B-02.

DIM	MILLIMETERS			INCHES		
	MIN	NOM	MAX	MIN	NOM	MAX
A	0.80	0.95	1.10	0.031	0.037	0.043
A1	0.00	0.05	0.10	0.000	0.002	0.004
A3	0.20 REF			0.008 REF		
b	0.10	0.21	0.30	0.004	0.008	0.012
C	0.10	0.14	0.25	0.004	0.005	0.010
D	1.80	2.00	2.20	0.070	0.078	0.086
E	1.15	1.25	1.35	0.045	0.049	0.053
e	0.65 BSC			0.026 BSC		
L	0.10	0.20	0.30	0.004	0.008	0.012
HE	2.00	2.10	2.20	0.078	0.082	0.086

STYLE 26:

- PIN 1. SOURCE 1
2. GATE 1
3. DRAIN 2
4. SOURCE 2
5. GATE 2
6. DRAIN 1

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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